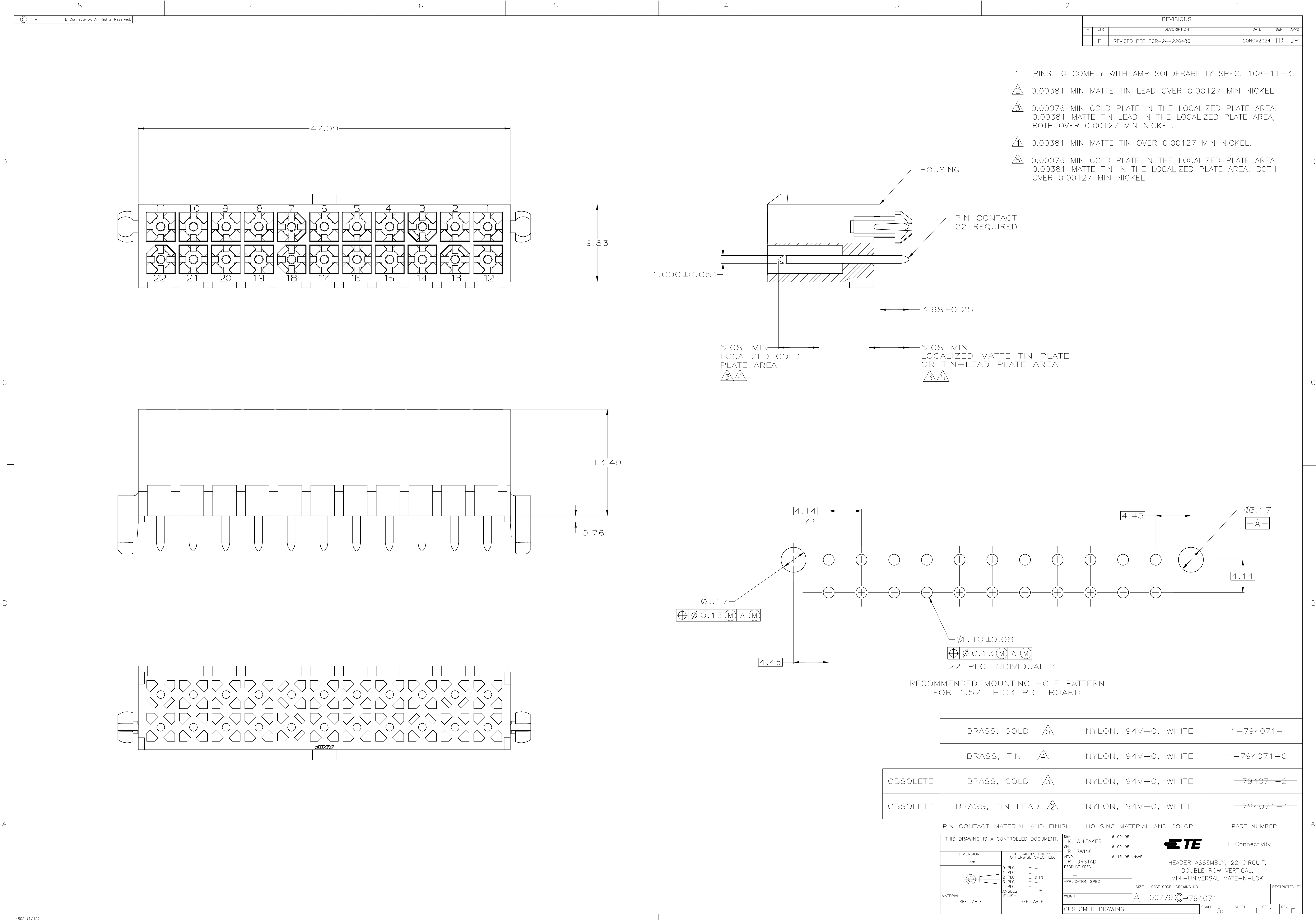




REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
F		REVISED PER ECR-24-226486	20NOV2024	TB	JP

1. PINS TO COMPLY WITH AMP SOLDERABILITY SPEC. 108-11-3.
- △ 0.00381 MIN MATTE TIN LEAD OVER 0.00127 MIN NICKEL.
- △ 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN LEAD IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.
- △ 0.00381 MIN MATTE TIN OVER 0.00127 MIN NICKEL.
- △ 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.

	BRASS, GOLD △	NYLON, 94V-0, WHITE	1-794071-1
	BRASS, TIN △	NYLON, 94V-0, WHITE	1-794071-0
OBSOLETE	BRASS, GOLD △	NYLON, 94V-0, WHITE	794071-2
OBSOLETE	BRASS, TIN LEAD △	NYLON, 94V-0, WHITE	794071-1

PIN CONTACT MATERIAL AND FINISH		HOUSING MATERIAL AND COLOR		PART NUMBER	
THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN K. WHITAKER 6-09-95	 TE Connectivity		
		CHK R. SWING 6-09-95			
DIMENSIONS: mm		APVD R. ORSTAD 6-13-95	NAME		
		PRODUCT SPEC			HEADER ASSEMBLY, 22 CIRCUIT, DOUBLE ROW VERTICAL, MINI-UNIVERSAL MATE-N-LOK
		APPLICATION SPEC			
		WEIGHT			
		SIZE CASE CODE DRAWING NO			
MATERIAL SEE TABLE	FINISH SEE TABLE	A100779C794071			RESTRICTED TO —
CUSTOMER DRAWING		SCALE 5:1		SHEET 1 OF 1	REV F